

MC10H102FNG Datasheet



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DiGi Electronics Part Number	MC10H102FNG-DG
Manufacturer	onsemi
Manufacturer Product Number	MC10H102FNG
Description	IC GATE NOR 4CH 2-INP 20PLCC
Detailed Description	NOR Gate IC 4 Channel 1 of 4 OR/NOR Output 20-PLCC (9x9)



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Purchase and inquiry

Manufacturer Product Number:

MC10H102FNG

Series:

10H

Logic Type:

NOR Gate

Number of Inputs:

2

Voltage - Supply:

-4.94V ~ -5.46V

Input Logic Level - Low:

-1.48V

Max Propagation Delay @ V, Max CL:

1.25ns @ -5.2V, -

Mounting Type:

Surface Mount

Package / Case:

20-LCC (J-Lead)

Manufacturer:

onsemi

Product Status:

Obsolete

Number of Circuits:

4

Features:

1 of 4 OR/NOR Output

Current - Output High, Low:

50mA, 50mA

Input Logic Level - High:

-1.13V

Operating Temperature:

0°C ~ 75°C

Supplier Device Package:

20-PLCC (9x9)

Base Product Number:

MC10H102

Environmental & Export classification

Moisture Sensitivity Level (MSL):

3 (168 Hours)

ECCN:

EAR99

REACH Status:

REACH Unaffected

HTSUS:

8542.39.0001

MC10H102

Quad 2-Input NOR Gate

Description

The MC10H102 is a quad 2-input NOR gate. The MC10H102 provides one gate with OR/NOR outputs. This MECL 10H™ part is a functional/pinout duplication of the standard MECL 10K™ family part, with 100% improvement in propagation delay, and no increases in power – supply current.

Features

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 25 mW/Gate (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K Compatible
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

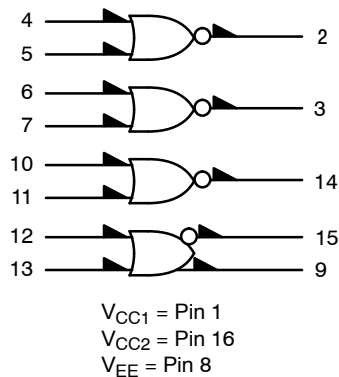
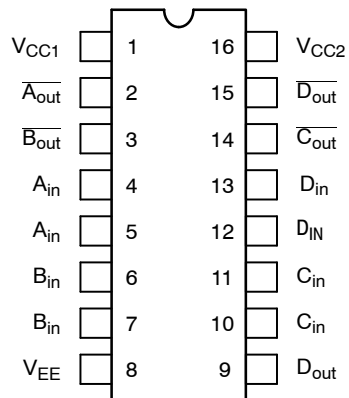


Figure 1. Logic Diagram



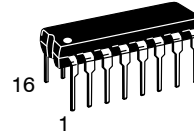
Pin assignment is for Dual-in-Line Package.

Figure 2. Pin Assignment

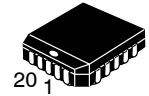


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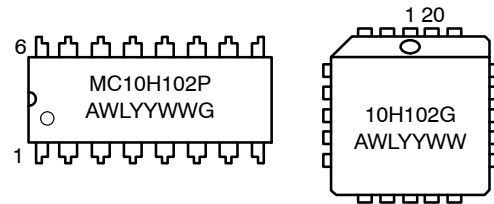


PDIP-16
P SUFFIX
CASE 648-08



PLCC-20
FN SUFFIX
CASE 775-02

MARKING DIAGRAMS*



A = Assembly Location
 WL, L = Wafer Lot
 YY, Y = Year
 WW, W = Work Week
 G = Pb-Free Package

*For additional marking information, refer to Application Note [AND8002/D](#).

ORDERING INFORMATION

Device	Package	Shipping†
MC10H102FNR2G	PLCC-20 (Pb-Free)	500/Tape & Reel
MC10H102PG	PDIP-16 (Pb-Free)	25 Units/Tube

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

MC10H102**Table 1. MAXIMUM RATINGS**

Symbol	Characteristic	Rating	Unit
V_{EE}	Power Supply ($V_{CC} = 0$)	-8.0 to 0	Vdc
V_I	Input Voltage ($V_{CC} = 0$)	0 to V_{EE}	Vdc
I_{out}	Output Current Continuous Surge	50 100	mA
T_A	Operating Temperature Range	0 to +75	°C
T_{stg}	Storage Temperature Range Plastic Ceramic	-55 to +150 -55 to +165	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 2. ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$) (Note 1)

Symbol	Characteristic	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
I_E	Power Supply Current	-	29	-	26	-	29	mA
I_{inH}	Input Current High	-	425	-	265	-	265	μA
I_{inL}	Input Current Low	0.5	-	0.5	-	0.3	-	μA
V_{OH}	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V_{OL}	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V_{IH}	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V_{IL}	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

- Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained. Outputs are terminated through a 50 Ω resistor to -2.0 V.

Table 3. AC CHARACTERISTICS

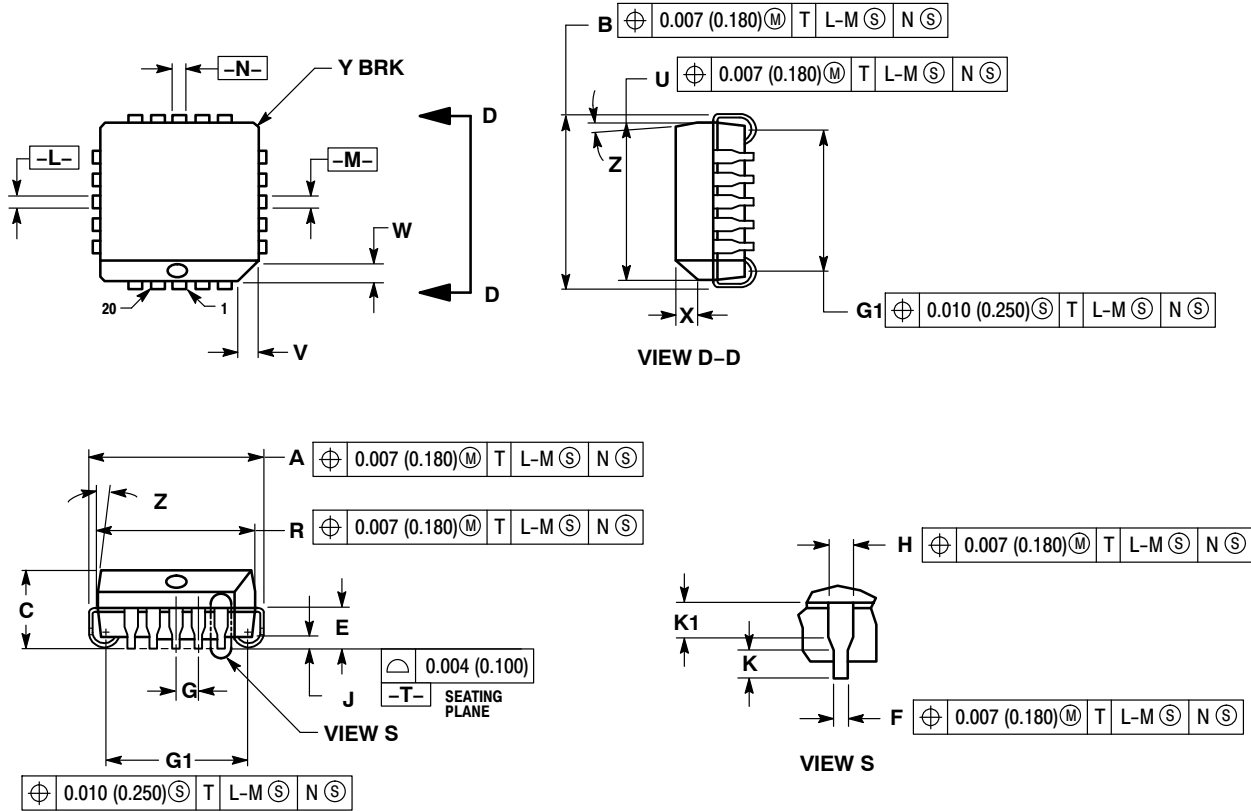
Symbol	Characteristic	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
t_{pd}	Propagation Delay	0.4	1.25	0.4	1.25	0.4	1.4	ns
t_r	Rise Time	0.5	1.5	0.5	1.6	0.55	1.7	ns
t_f	Fall Time	0.5	1.5	0.5	1.6	0.55	1.7	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

MC10H102

PACKAGE DIMENSIONS

20 LEAD PLLC
CASE 775-02
ISSUE F



NOTES:

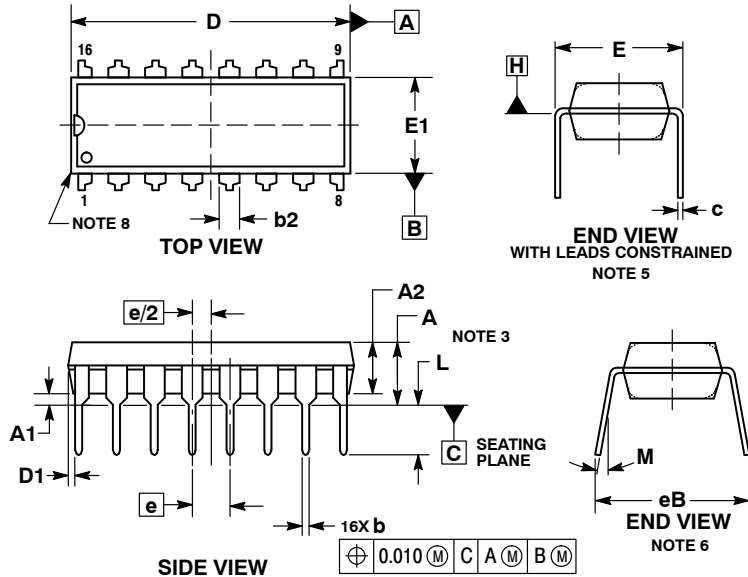
1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982.
2. DIMENSIONS IN INCHES.
3. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
4. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
5. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
6. DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.021	0.33	0.53
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	----	0.51	----
K	0.025	----	0.64	----
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	----	0.020	----	0.50
Z	2° 10°		2° 10°	
G1	0.310	0.330	7.88	8.38
K1	0.040	----	1.02	----

MC10H102

PACKAGE DIMENSIONS

PDIP-16
CASE 648-08
ISSUE V



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: INCHES.
 3. DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.
 4. DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
 5. DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
 6. DIMENSION eB IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED.
 7. DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
 8. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS).

- STYLE 1:
1. CATHODE
 2. CATHODE
 3. CATHODE
 4. CATHODE
 5. CATHODE
 6. CATHODE
 7. CATHODE
 8. CATHODE
 9. ANODE
 10. ANODE
 11. ANODE
 12. ANODE
 13. ANODE
 14. ANODE
 15. ANODE
 16. ANODE
- STYLE 2:
1. COMMON DRAIN
 2. COMMON DRAIN
 3. COMMON DRAIN
 4. COMMON DRAIN
 5. COMMON DRAIN
 6. COMMON DRAIN
 7. COMMON DRAIN
 8. COMMON DRAIN
 9. GATE
 10. SOURCE
 11. GATE
 12. SOURCE
 13. GATE
 14. SOURCE
 15. GATE
 16. SOURCE

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